

UMF Equipment - Protochips Fusion Select System

Heating, Electrical or Electrothermal in TEM

Fusion Select transforms the TEM into an in-situ laboratory using the flexibility of MEMS-based E-chips that deliver accurate, precise experimental conditions. Capable of sourcing and measuring Pico amp level electrical signals and swift temperature changes up to 1200 °C, Fusion Select offers unmatched versatility and capability, accelerating results. The heating E-chips feature a unique silicon carbide heating membrane, which is highly thermally and chemically stable, and are available with a silicon nitride film, an amorphous holey carbon film and through hole. All E-chips can reach up to 1200 °C temperature, heat uniformity, and maintain 5% temperature accuracy.

Features: Heating: RT-1200 °C

- Accuracy ~5%
- Heating Rate: 1000 °C/ms

Ultra-Low Drift
EDS & EELS Capable
Operation - Full Software Control
Simultaneous Heating & Electrical Biasing

Please refer to <https://www.protochips.com/products/fusion/> for further details of the system.
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Application:

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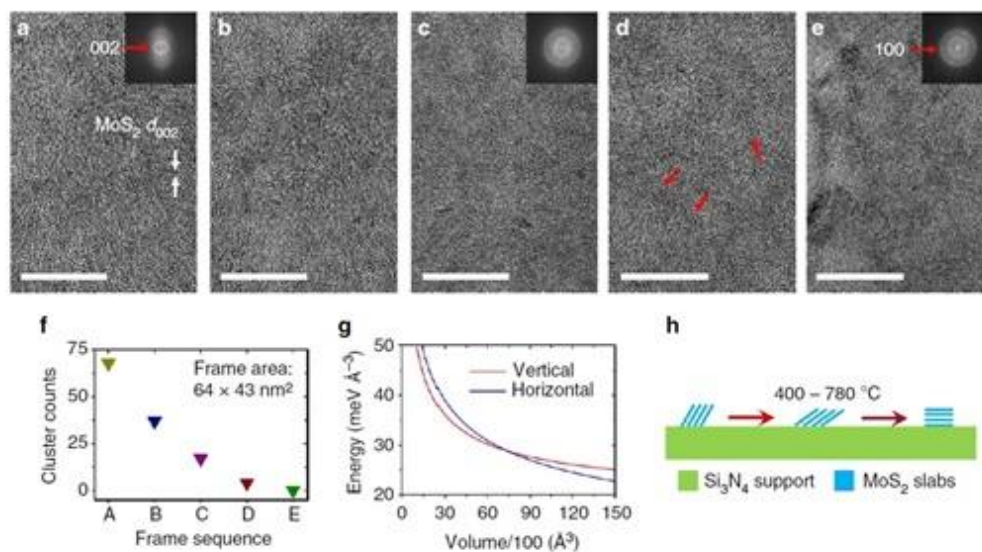


Figure 3 | Vertical-to-horizontal transition from 400 to 780 °C. (a–e) TEM images versus the increasing temperatures: (a) 400 °C, (b) 500 °C, (c) 600 °C, (d) 700 °C and (e) 780 °C. The insets in a,c,e are the corresponding fast Fourier transform (FFT) patterns. The red arrows in d denote the vertical MoS₂ structures at 700 °C to provide better illustration. Scale bars, 20 nm. (f) Statistical distribution of the counts of the vertical MoS₂ flakes in frames a–e. (g) The energy density of MoS₂ structures along two orientations as a function of their volumes, showing the competition of total system energy between the vertical and horizontal structures during crystal growth. (h) Schematic process of the vertical-to-horizontal transition.